### ES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF:

SERIAL NO:

10/083,598

GAU:

2859

FILED:

February 27, 2002

**EXAMINER:** 

FOR:

THERMOELECTRIC MODULE AND METHOD OF ASSEMBLING THE THERMOELECTRIC

RADIATING MEMBER

# INFORMATION DISCLOSURE/RELATED CASE STATEMENT UNDE

ASSISTANT COMMISSIONER FOR PATENTS WASHINGTON, D.C. 20231

SIR:

Applicant(s) wish to disclose the following information.

#### REFERENCES

- The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- A check is attached in the amount required under 37 CFR §1.17(p).

#### RELATED CASES

- Attached is a list of applicant's pending application(s) or issued patent(s) which may be related to the present application. A copy of the patent(s), together with a copy of the claims and drawings of the pending application(s) is attached along
- ☐ A check is attached in the amount required under 37 CFR §1.17(p).

#### CERTIFICATION

- ☐ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

#### **DEPOSIT ACCOUNT**

■ Please charge any additional fees for the papers being filed herewith and for which no check is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

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Surinder Sachar Registration No. 34,423

22850

DOCKET NO: 220130US2X

10/083,598

Sheet \_\_\_\_ of \_\_\_

SERIAL NO:

Group Art Unit: 2859

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STATEMENT OF RELEVANCY

Reference AV on Form 1449:

This reference discloses a thermoelectric module for thermoelectric cooling in which upper and lower substrates are the same in size in Fig. 3.13.

TECHNOLOGY CENTER 2800

TC 1700 MAIL ROOM

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Form PTO 1449 (Modified)	HEN	U.S. DEPARTMENT OF PATERY AND TRADEN	COMMERCE MARK OFFICE	ATTY DOCKET NO 22	). 0130US2X		SERIAL N		3,598		
LIST OF I	REFER	RENCES CITED BY APPL	.ICANT	APPLICANT Masato ITAKURA			A, et al.				
			FILING DATE February 27, 2002			GROUP 2859					
			1	U.S. PATENT DOCU	IMENTS						
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## **LIST OF RELATED CASES**

Docket Number	Serial or Patent No.	Filing or Issue Date	Status or Patentee
213731US2	09/964,371	09/28/01	PENDING
218198US2	10/059,392	01/31/02	PENDING
220130US2X*	10/083,598	02/27/02	PENDING

\*Present application; listed for information GJM/ae
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